

SWITCHMODE Power Rectifier

MUR260

These state-of-the-art devices are designed for use in switching power supplies, inverters and as free wheeling diodes.

Features

- Ultrafast 50 Nanosecond Recovery Times
- 175 °C Operating Junction Temperature
- Low Forward Voltage
- Low Leakage Current
- High Temperature Glass Passivated Junction
- These are Pb-Free Devices*

Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 0.4 Gram (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260 °C Max. for 10 Seconds
- Shipped in Plastic Bags; 1,000 per Bag
- Available Tape and Reel; 5,000 per Reel, by Adding a "RL" Suffix to the Part Number

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$egin{array}{c} V_{RRM} \ V_{RWM} \ V_{R} \end{array}$	600 -	V
Average Rectified Forward Current (Note 2) (Square Wave Mounting Method #3 Per Note 4)	I _{F(AV)}	2.0 @ T _A = 60 °C	Α
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	I _{FSM}	35	A
Operating Junction Temperature and Storage Temperature Range	T _J , T _{stg}	-65 to +175	°C

THERMAL CHARACTERISTICS

Characteristics	Symbol	Value	Unit
Maximum Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	See Note 4	°C/W

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 2. Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤ 2.0%.
- For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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ULTRAFAST RECTIFIER 2.0 AMPERES, 600 VOLTS





MARKING DIAGRAM



= Assembly Location

= Year

WW = Work Week

= Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]	
MUR260RLG	Axial Lead**	5000/Tape & Reel	

DISCONTINUED (Note 1)

MUR260	Axial Lead**	1000 Units/Bag	
MUR260G	Axial Lead**	1000 Units/Bag	
MUR260RL	Axial Lead**	5000/Tape & Reel	

- † For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.
- This package is inherently Pb-Free.
- 1. **DISCONTINUED:** These devices are not recommended for new design. Please contact your onsemi representative for information. The most current information on these devices may be available on www.onsemi.com.

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ELECTRICAL CHARACTERISTICS

Characteristics	Symbol	Value	Unit
Maximum Instantaneous Forward Voltage (Note 3) (IF = 2.0 Amp, T_J = 150 °C) (IF = 2.0 Amp, T_J = 25 °C)	VF	1.15 1.35	V
Maximum Instantaneous Reverse Current (Note 3) (Rated dc Voltage, T_J = 150 °C) (Rated dc Voltage, T_J = 25 °C)	i _R	150 5.0	μА
Maximum Reverse Recovery Time ($I_F = 1.0 \text{ Amp}$, $di/dt = 50 \text{ Amp/}\mu s$) ($I_F = 0.5 \text{ Amp}$, $I_R = 1.0 \text{ Amp}$, $I_{REC} = 0.25 \text{ A}$)	t _{rr}	75 50	ns
Maximum Forward Recovery Time (I _F = 1.0 A, di/dt = 100 A/μs, I _{REC} to 1.0 V)	t _{fr}	50	ns

^{3.} Pulse Test: Pulse Width = 300 µs, Duty Cycle ≤ 2.0%.

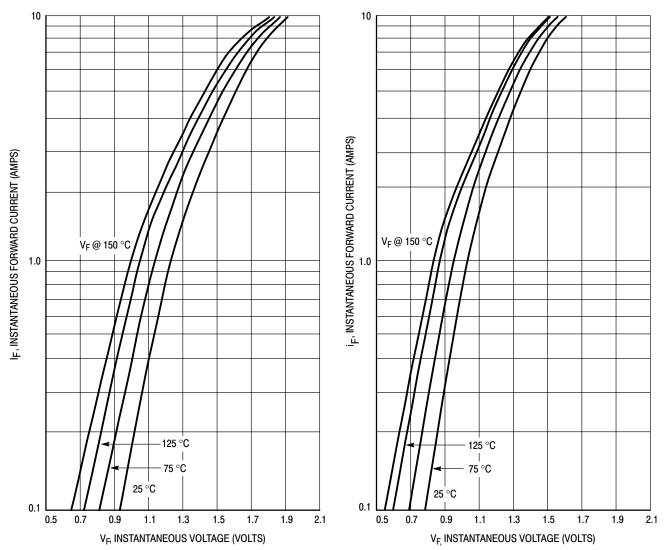


Figure 1. Maximum Forward Voltage

Figure 2. Typical Forward Voltage

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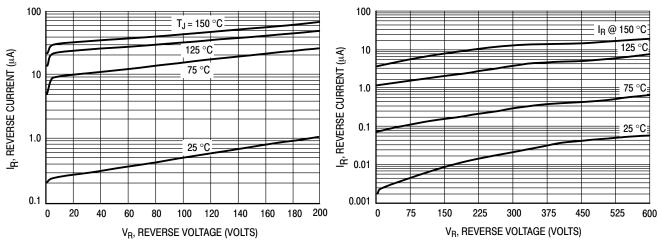
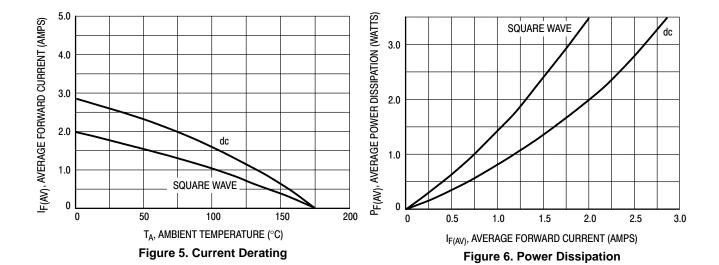


Figure 3. Maximum Reverse Current

Figure 4. Typical Reverse Current



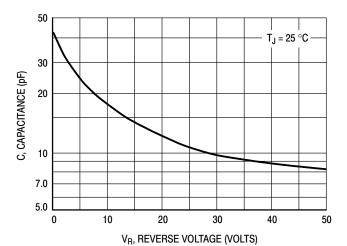


Figure 7. Typical Capacitance

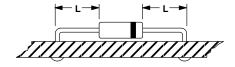
NOTE 4 — AMBIENT MOUNTING DATA

Data shown for thermal resistance, junction-to-ambient $(R_{\theta JA})$ for the mountings shown is to be used as typical guideline values for preliminary engineering or in case the tie point temperature cannot be measured.

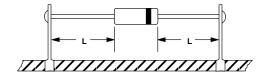
TYPICAL VALUES FOR $R_{\theta \text{JA}}$ IN STILL AIR

Mounting		Lead Length, L			
Method		1/8	1/4	1/2	Units
1		52	65	72	°C/W
2	$R_{\theta JA}$	67	80	87	°C/W
3			50		°C/W

MOUNTING METHOD 1

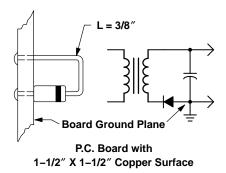


MOUNTING METHOD 2



Vector Pin Mounting

MOUNTING METHOD 3



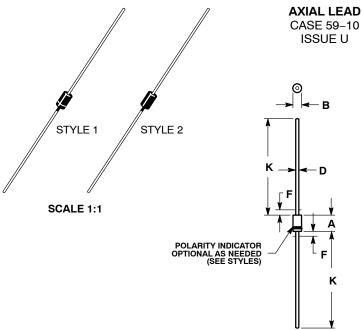
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REVISION HISTORY

Revision	Description of Changes	Date
8	Rebranded the Data Sheet to onsemi format. MUR260, MUR260G, MUR260RL OPN marked as Discontinued.	10/13/2025

This document has undergone updates prior to the inclusion of this revision history table. The changes tracked here only reflect updates made on the noted approval dates.





STYLE 1: PIN 1. CATHODE (POLARITY BAND) 2. ANODE

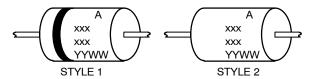
DATE 15 FEB 2005

- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI
- Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.

- 2. CONTHOLLING DIMENSION: INCH.
 3. ALL RULES AND NOTES ASSOCIATED WITH JEDEC DO-41 OUTLINE SHALL APPLY
 4. POLARITY DENOTED BY CATHODE BAND.
 5. LEAD DIAMETER NOT CONTROLLED WITHIN F DIMENSION.

ſ		INCHES		MILLIM	ETERS
L	DIM	MIN MAX		MIN	MAX
	Α	0.161	0.205	4.10	5.20
Γ	В	0.079	0.106	2.00	2.70
	D	0.028	0.034	0.71	0.86
	F		0.050		1.27
	K	1.000		25.40	

GENERIC MARKING DIAGRAM*



= Specific Device Code XXX = Assembly Location Α

YY = Year

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

= Work Week WW

NO POLARITY

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